



SGM8091/SGM8092 SGM8093/SGM8094 350MHz, Rail-to-Rail Output CMOS Operational Amplifiers

GENERAL DESCRIPTION

The SGM8091/3 (single), SGM8092 (dual) and SGM8094 (quad) are high speed operational amplifiers, which can operate from 2.5V to 5.5V single supply. The SGM8091/2/3/4 feature an 8mV maximum input offset voltage and offer a low supply current of 4.3mA/amplifier.

The SGM8091/2/3/4 have excellent performance. They have a bandwidth and slew rate usually exist in current feedback amplifiers. They exhibit a wide bandwidth of 350MHz (G=+1) and a 0.1dB gain flatness of 70MHz (G=+1).

The SGM8091/2/3/4 provide wide input common mode voltage range and rail-to-rail output swing. The fast settling time and low distortion make the operational amplifiers appropriate for high speed ADC/DAC. The supply current of SGM8093 is 75 μ A in shutdown mode. The devices are suitable for use in portable instrumentation and battery-powered systems. They are specified over the extended -40 $^{\circ}$ C to +125 $^{\circ}$ C temperature range.

APPLICATIONS

ADC
DVD
Filter
Hand Set
Imaging
Base Station
Photodiode Preamp

FEATURES

- **High Speed:**
 - 3dB Bandwidth (G = +1): 350MHz
 - Slew Rate: 265V/ μ s
 - Settling Time to 0.1% with 2V Step: 32ns
- **Excellent Video Performance ($R_L = 150\Omega$, G = +2):**
 - 0.1dB Gain Flatness: 70MHz
 - Diff Gain: 0.004%, Diff Phase: 0.08 $^{\circ}$
- **Input Offset Voltage: 8mV (MAX)**
- **Rail-to-Rail Output**
- **Supply Voltage Range: 2.5V to 5.5V**
- **Input Common Mode Voltage Range:**
 - 0.2V to 3.8V with $V_S = 5V$
- **Low Supply Current:**
 - 4.3mA/Amplifier (TYP)
 - 75 μ A Shutdown Current for SGM8093
- **-40 $^{\circ}$ C to +125 $^{\circ}$ C Operating Temperature Range**
- **Small Packaging:**
 - SGM8091 Available in Green SOIC-8 and SOT-23-5 Packages
 - SGM8092 Available in Green SOIC-8 and MSOP-8 Packages
 - SGM8093 Available in Green SOIC-8 and SOT-23-6 Packages
 - SGM8094 Available in Green SOIC-14 and TSSOP-14 Packages

PACKAGE/ORDERING INFORMATION

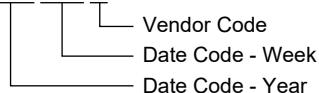
MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION
SGM8091	SOT-23-5	-40°C to +125°C	SGM8091XN5/TR	8091	Tape and Reel, 3000
	SOIC-8	-40°C to +125°C	SGM8091XS/TR	SGM8091XS XXXXX	Tape and Reel, 2500
SGM8092	SOIC-8	-40°C to +125°C	SGM8092XS/TR	SGM8092XS XXXXX	Tape and Reel, 2500
	MSOP-8	-40°C to +125°C	SGM8092XMS/TR	SGM8092 XMS XXXXX	Tape and Reel, 3000
SGM8093	SOT-23-6	-40°C to +125°C	SGM8093XN6/TR	8093	Tape and Reel, 3000
	SOIC-8	-40°C to +125°C	SGM8093XS/TR	SGM8093XS XXXXX	Tape and Reel, 2500
SGM8094	SOIC-14	-40°C to +125°C	SGM8094XS14/TR	SGM8094XS14 XXXXX	Tape and Reel, 2500
	TSSOP-14	-40°C to +125°C	SGM8094XTS14/TR	SGM8094 XTS14 XXXXX	Tape and Reel, 3000

MARKING INFORMATION

NOTE: XXXXX = Date Code and Vendor Code.

SOIC-8/MSOP-8/SOIC-14/TSSOP-14

XXXXX



Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

ABSOLUTE MAXIMUM RATINGS

Supply Voltage, +Vs to -Vs	7.5V
Input Common Mode Voltage Range (-Vs) - 0.5V to (+Vs) + 0.5V	
Package Thermal Resistance @ TA = +25°C	
SOT-23-5, θJA	190°C/W
SOT-23-6, θJA	190°C/W
SOIC-8, θJA.....	125°C/W
MSOP-8, θJA	216°C/W
Junction Temperature.....	+150°C
Storage Temperature Range	-65°C to +150°C
Lead Temperature (Soldering, 10s).....	+260°C
ESD Susceptibility	
HBM.....	1000V
MM.....	400V

RECOMMENDED OPERATING CONDITIONS

Operating Temperature Range	-40°C to +125°C
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OVERSTRESS CAUTION

Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.

ESD SENSITIVITY CAUTION

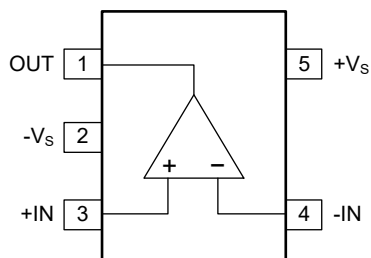
This integrated circuit can be damaged if ESD protections are not considered carefully. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because even small parametric changes could cause the device not to meet the published specifications.

DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

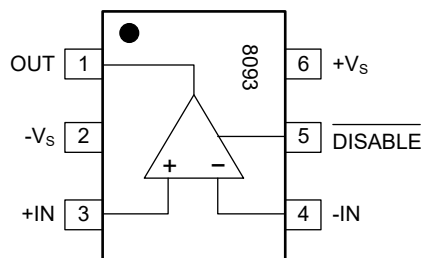
PIN CONFIGURATIONS

SGM8091 (TOP VIEW)



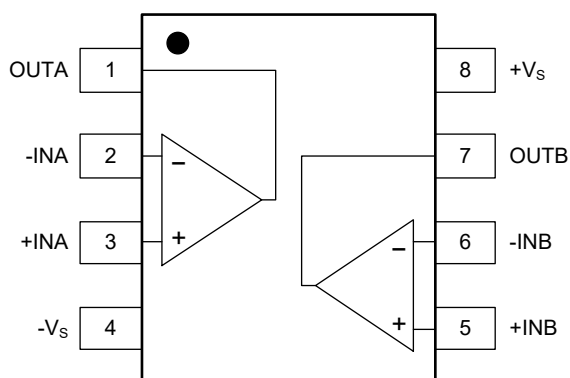
SOT-23-5

SGM8093 (TOP VIEW)



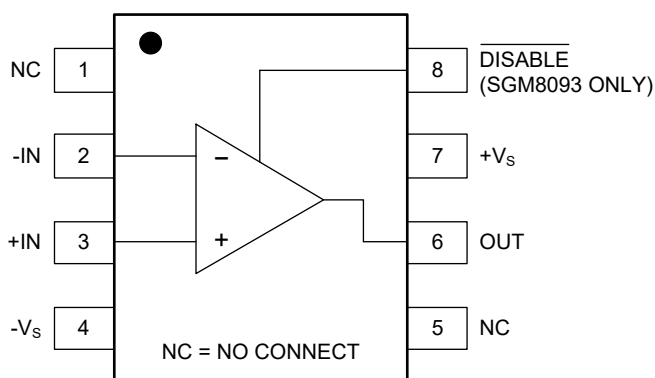
SOT-23-6

SGM8092 (TOP VIEW)



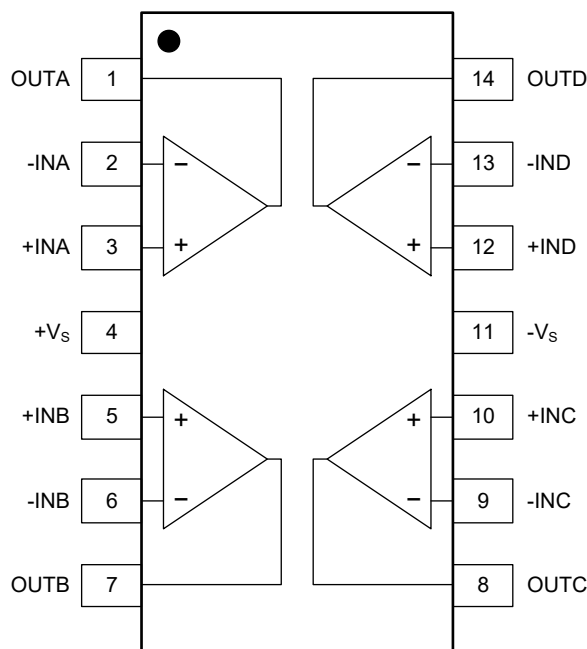
SOIC-8/MSOP-8

SGM8091/8093 (TOP VIEW)



SOIC-8

SGM8094 (TOP VIEW)



SOIC-14/TSSOP-14

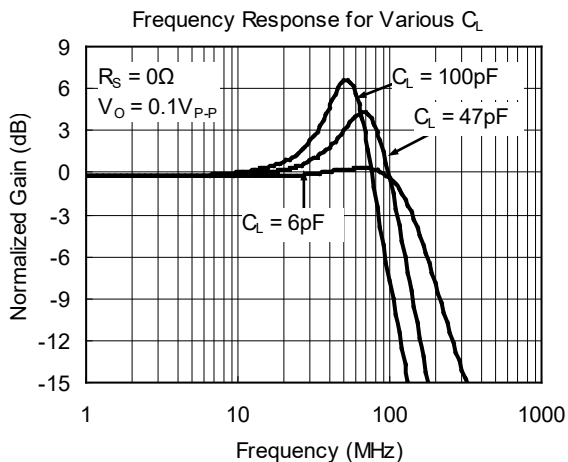
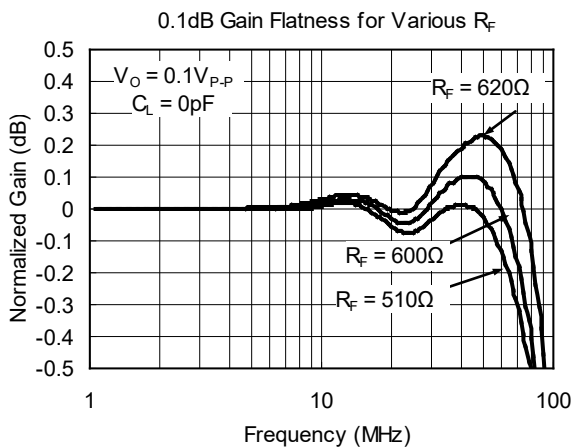
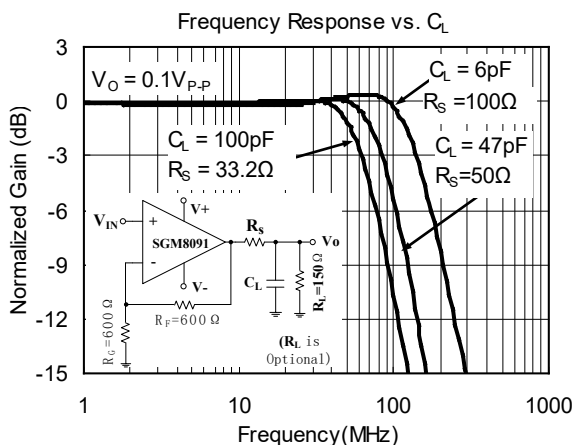
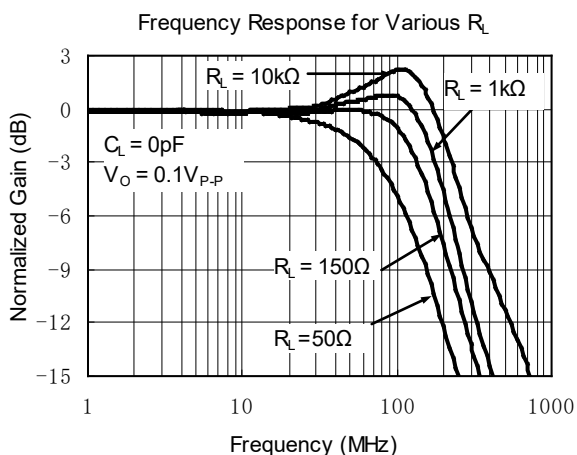
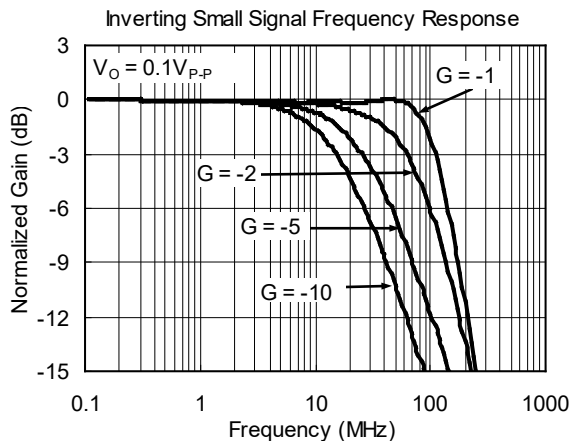
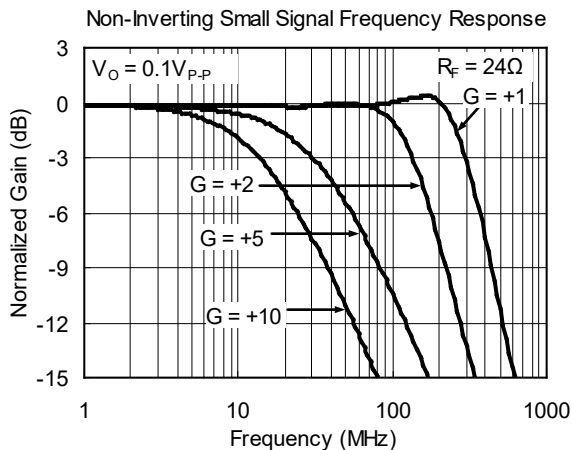
ELECTRICAL CHARACTERISTICS

($V_S = 5V$, $G = +2$, $R_F = 600\Omega$, $R_L = 150\Omega$, unless otherwise noted.)

PARAMETER	CONDITIONS	SGM8091/2/3/4							
		TYP	MIN/MAX OVER TEMPERATURE					UNITS	MIN/MAX
		+25°C	+25°C	0°C to +70°C	-40°C to +70°C	-40°C to +125°C			
Dynamic Performance									
-3dB Small Signal Bandwidth	$G = +1, V_O = 0.1V_{P-P}, R_F = 24\Omega, R_L = 150\Omega$	300						MHz	TYP
	$G = +1, V_O = 0.1V_{P-P}, R_F = 24\Omega, R_L = 1k\Omega$	350						MHz	TYP
	$G = +2, V_O = 0.1V_{P-P}, R_L = 50\Omega$	70						MHz	TYP
	$G = +2, V_O = 0.1V_{P-P}, R_L = 150\Omega$	140						MHz	TYP
	$G = +2, V_O = 0.1V_{P-P}, R_L = 1k\Omega$	170						MHz	TYP
	$G = +2, V_O = 0.1V_{P-P}, R_L = 10k\Omega$	230						MHz	TYP
Gain-Bandwidth Product	$G = +10, R_L = 150\Omega$	135						MHz	TYP
	$G = +10, R_L = 1k\Omega$	170						MHz	TYP
Bandwidth for 0.1dB Flatness	$G = +1, V_O = 0.1V_{P-P}$	125						MHz	TYP
	$G = +2, V_O = 0.1V_{P-P}, R_F = 600\Omega$	70						MHz	TYP
Slew Rate	$G = +1, 2V$ output step	194/-204						V/ μ s	TYP
	$G = +2, 2V$ output step	236/-170						V/ μ s	TYP
	$G = +2, 4V$ output step	265/-218						V/ μ s	TYP
Rise-and-Fall Time	$G = +2, V_O = 0.2V_{P-P}, 10\%$ to 90%	3.8						ns	TYP
	$G = +2, V_O = 2V_{P-P}, 10\%$ to 90%	7.8						ns	TYP
Settling Time to 0.1%	$G = +2, 2V$ output step	32						ns	TYP
Overload Recovery Time	$V_{IN} \cdot G = +V_S$	14.5						ns	TYP
Noise/Distortion Performance									
Input Voltage Noise	$f = 1MHz$	5.9						nV/ \sqrt{Hz}	TYP
Differential Gain Error (NTSC)	$G = +2, R_L = 150\Omega$	0.004						%	TYP
Differential Phase Error (NTSC)	$G = +2, R_L = 150\Omega$	0.08						degree	TYP
DC Performance									
Input Offset Voltage (V_{OS})		± 2	± 8	± 8.9	± 9.5	± 9.8		mV	MAX
Input Offset Voltage Drift		3.7						$\mu V/^\circ C$	TYP
Input Bias Current (I_B)		6						PA	TYP
Input offset Current (I_{OS})		2						PA	TYP
Open-Loop Gain (A_{OL})	$V_O = 0.3V$ to $4.7V, R_L = 150\Omega$	80	75	74	74	73		dB	MIN
	$V_O = 0.2V$ to $4.8V, R_L = 1k\Omega$	104	92	91	91	80		dB	MIN
Input Characteristics									
Input Common Mode Voltage Range (V_{CM})		-0.2 to +3.8						V	TYP
Common Mode Rejection Ratio (CMRR)	$V_{CM} = -0.1V$ to $3.5V$	80	66	66	65	64		dB	MIN
Output Characteristics									
Output Voltage Swing from Rail	$R_L = 150\Omega$	0.12						V	TYP
	$R_L = 1k\Omega$	0.03						V	TYP
Output Current		115	98	97	94	88		mA	MIN
Closed-Loop Output Impedance	$f < 100kHz$	0.02						Ω	TYP
Power-Down Disable									
Turn-On Time		108						ns	TYP
Turn-Off Time		60						ns	TYP
$\overline{DISABLE}$ Voltage-Off			0.8					V	MAX
$\overline{DISABLE}$ Voltage-On			2					V	MIN
Power Supply									
Operating Voltage Range			2.5	2.7	2.7	2.7		V	MIN
			5.5	5.5	5.5	5.5		V	MAX
Quiescent Current (per Amplifier)		4.3	7.5	8.0	8.0	8.1		mA	MAX
Supply Current when Disabled (SGM8093 only)		75	120	127	130	137		μA	MAX
Power Supply Rejection Ratio (PSRR)	$\Delta V_S = 2.7V$ to $5.5V, V_{CM} = (-V_S) + 0.5$	80	66	66	64	62		dB	MIN

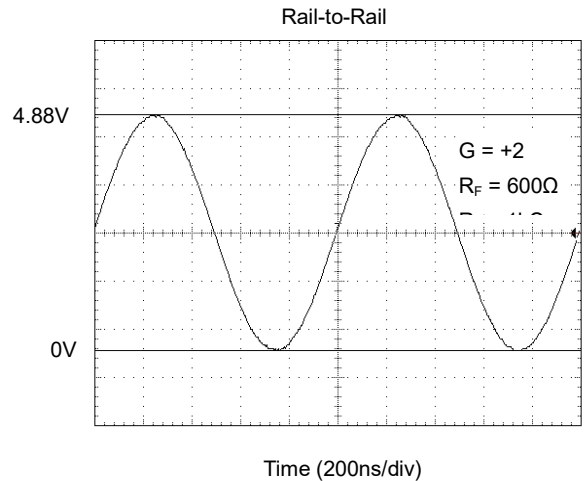
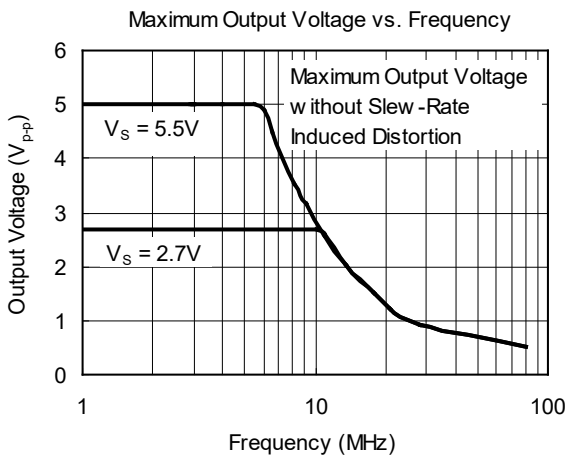
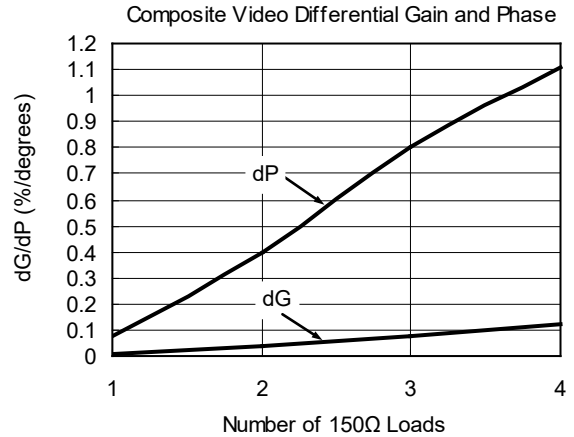
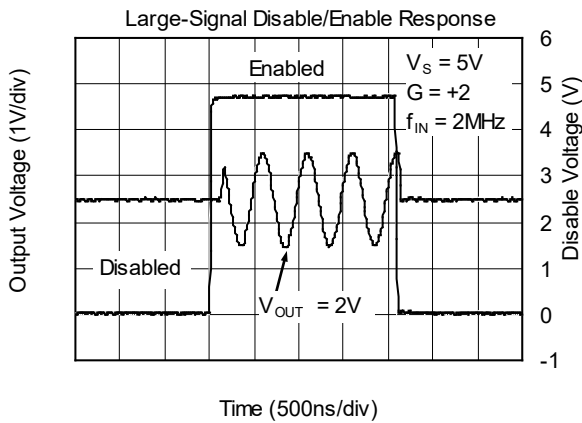
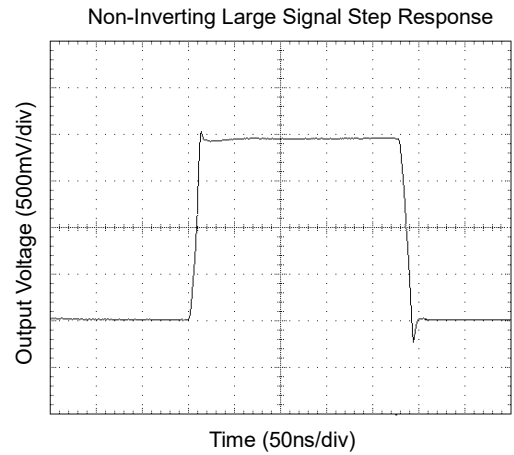
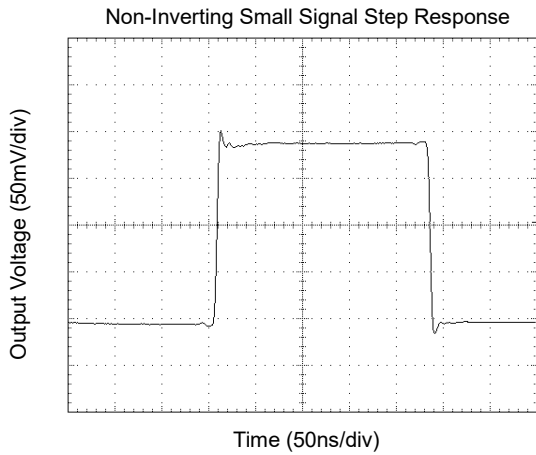
TYPICAL PERFORMANCE CHARACTERISTICS

At $T_A = +25^\circ\text{C}$, $V_S = 5\text{V}$, $G = +2$, $R_F = 600\Omega$, $R_G = 600\Omega$, and $R_L = 150\Omega$ connected to $V_S/2$, unless otherwise noted.



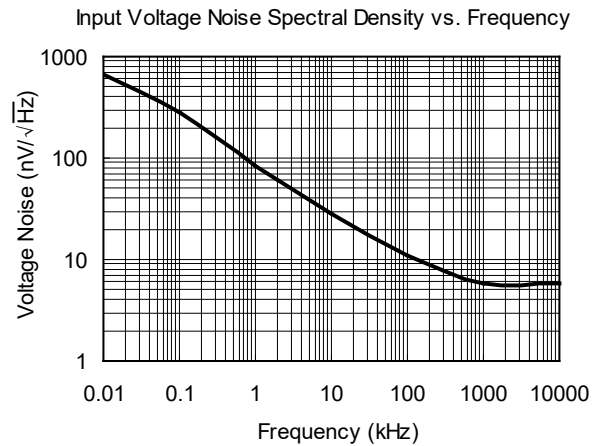
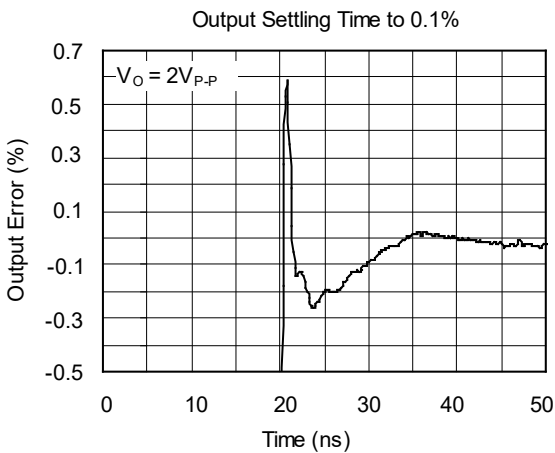
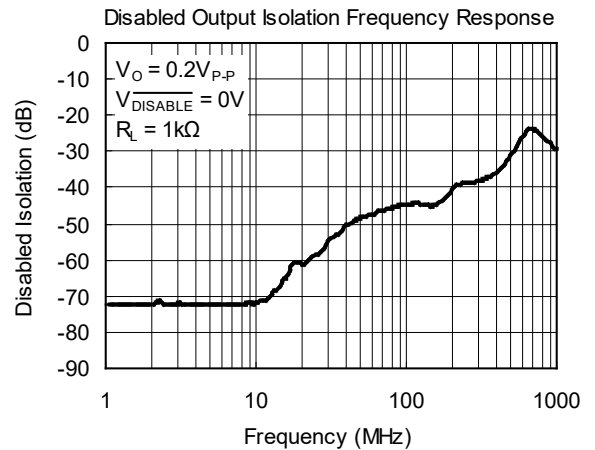
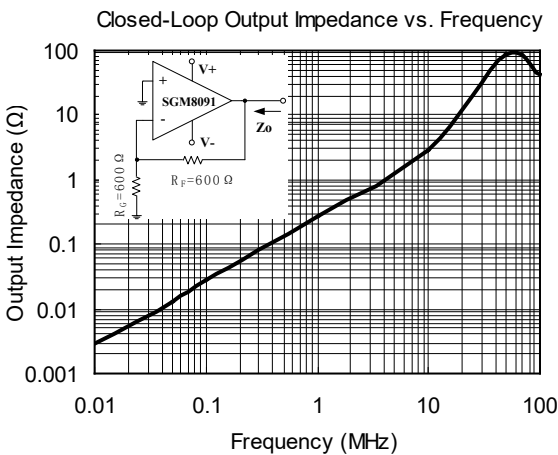
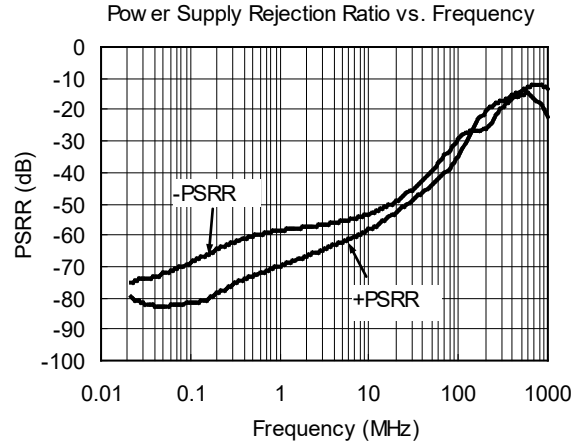
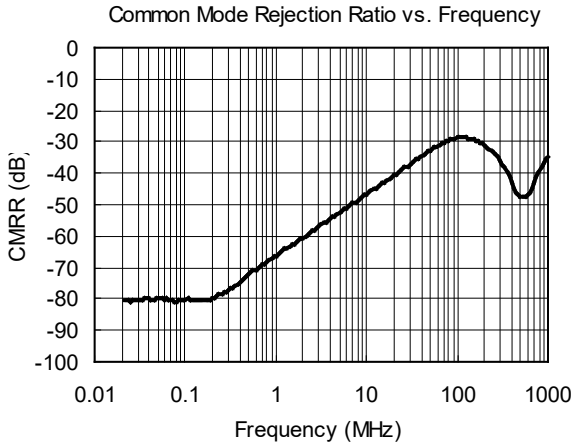
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

At $T_A = +25^\circ\text{C}$, $V_S = 5\text{V}$, $G = +2$, $R_F = 600\Omega$, $R_G = 600\Omega$, and $R_L = 150\Omega$ connected to $V_S/2$, unless otherwise noted.



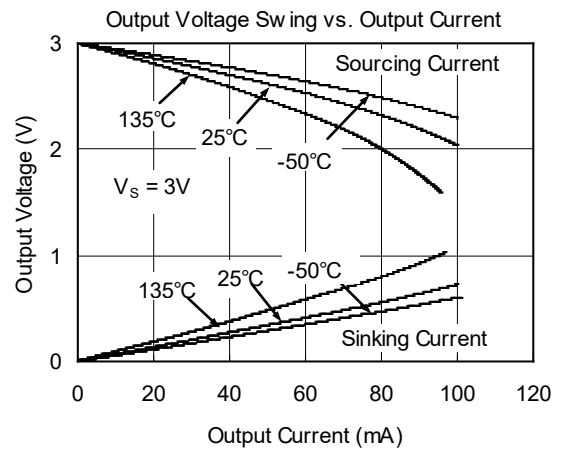
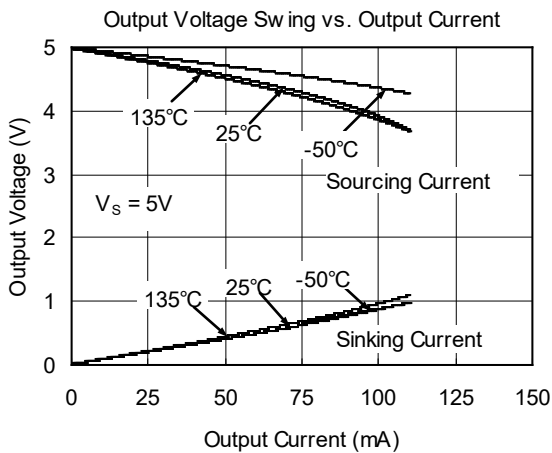
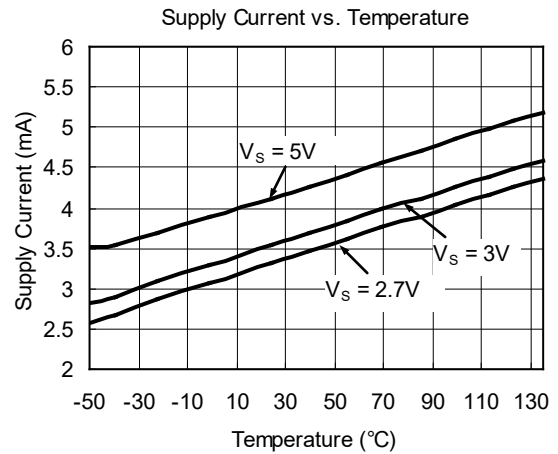
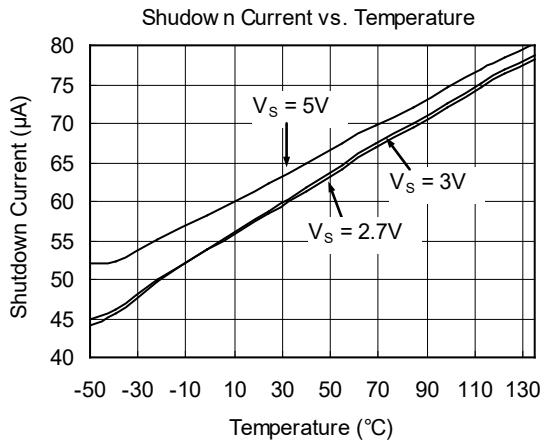
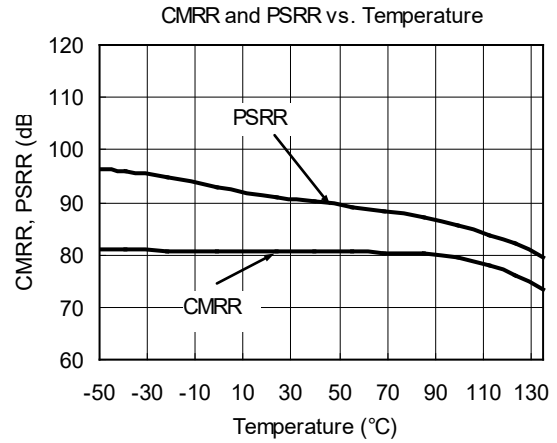
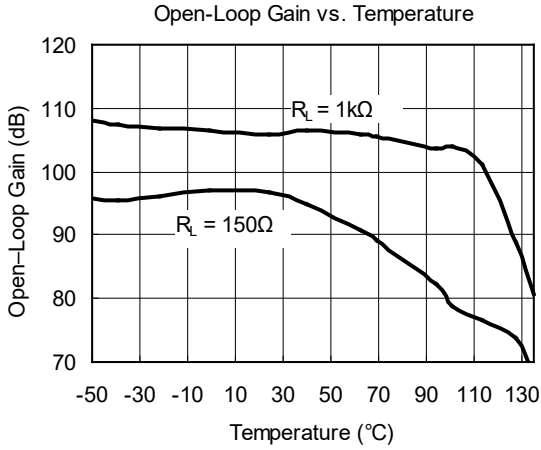
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

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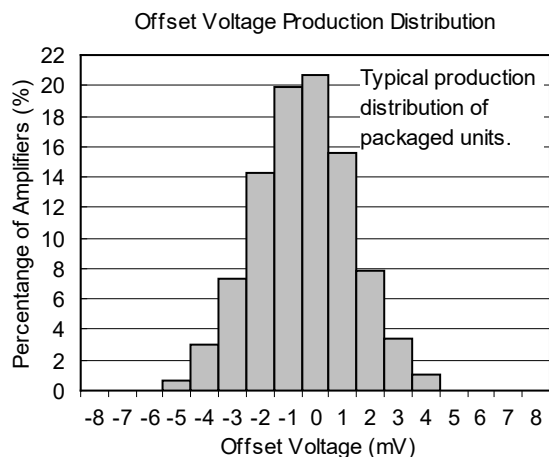
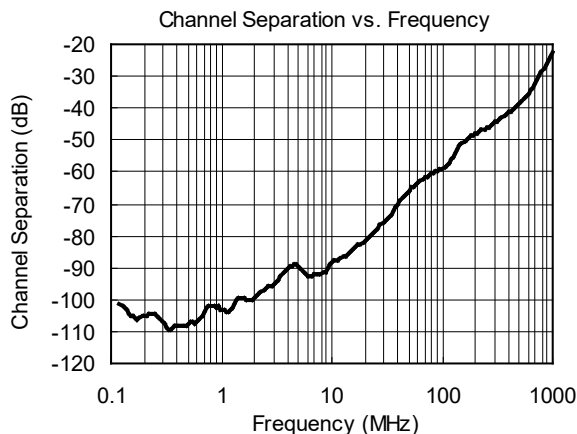
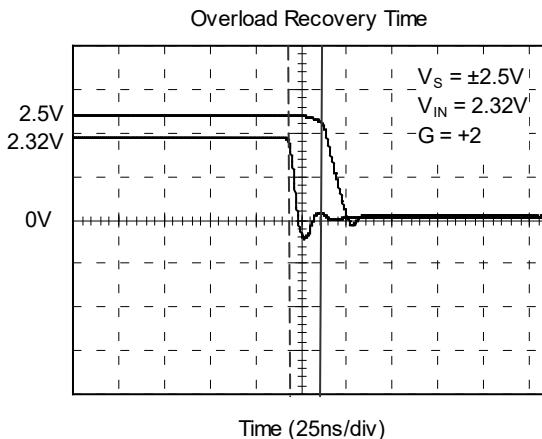
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

At $T_A = +25^\circ\text{C}$, $V_S = 5\text{V}$, $G = +2$, $R_F = 600\Omega$, $R_G = 600\Omega$, and $R_L = 150\Omega$ connected to $V_S/2$, unless otherwise noted.



TYPICAL PERFORMANCE CHARACTERISTICS (continued)

At $T_A = +25^\circ\text{C}$, $V_S = 5\text{V}$, $G = +2$, $R_F = 600\Omega$, $R_G = 600\Omega$, and $R_L = 150\Omega$ connected to $V_S/2$, unless otherwise noted.



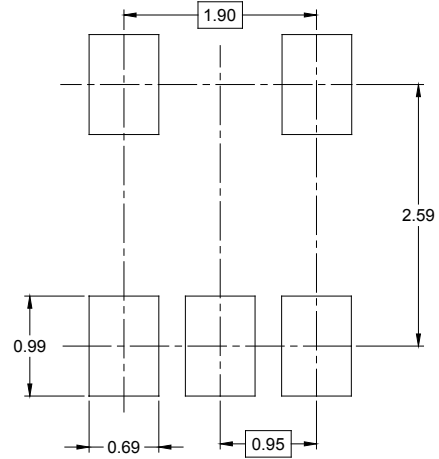
REVISION HISTORY

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

JANUARY 2013 – REV.B.3 to REV.B.4	Page
Updated Package Outline Dimensions section	14~19
Added Tape and Reel Information section	20, 21
<hr/>	
MAY 2011 – REV.B.2 to REV.B.3	Page
Changed packages' name	All
<hr/>	
JUNE 2010 – REV.B.1 to REV.B.2	Page
Changed Electrical Characteristics section	3
Changed Package Outline Dimensions section	11~16
<hr/>	
APRIL 2009 – REV.B to REV.B.1	Page
Changed 16pin packages to 14pin packages.....	All
<hr/>	
AUGUST 2008 – REV.A to REV.B	Page
Changed Absolute Maximum Ratings section	3
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Changes from Original (NOVEMBER 2006) to REV.A	Page
Changed from product preview to production data.....	All

PACKAGE OUTLINE DIMENSIONS

SOT-23-5



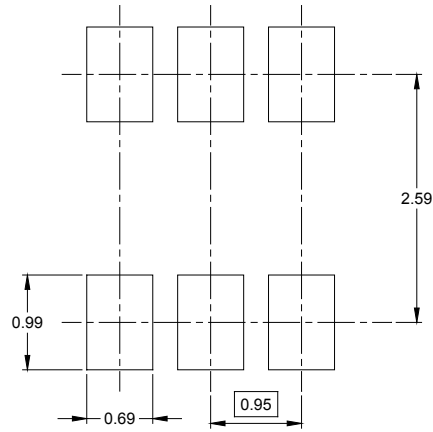
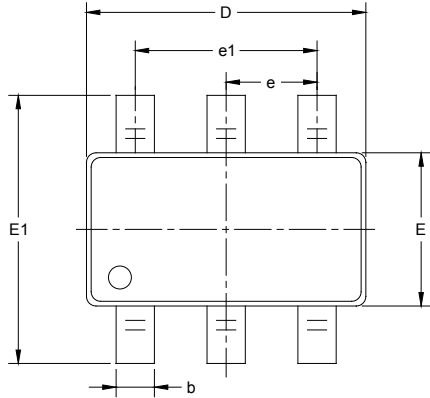
RECOMMENDED LAND PATTERN (Unit: mm)



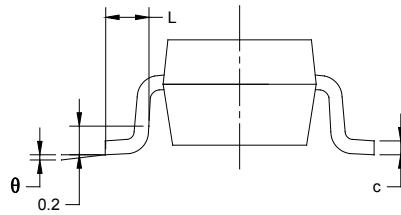
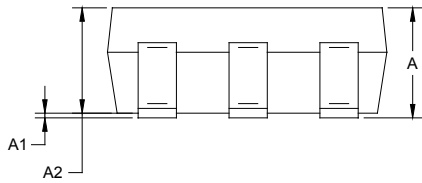
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950 BSC		0.037 BSC	
e1	1.900 BSC		0.075 BSC	
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

PACKAGE OUTLINE DIMENSIONS

SOT-23-6



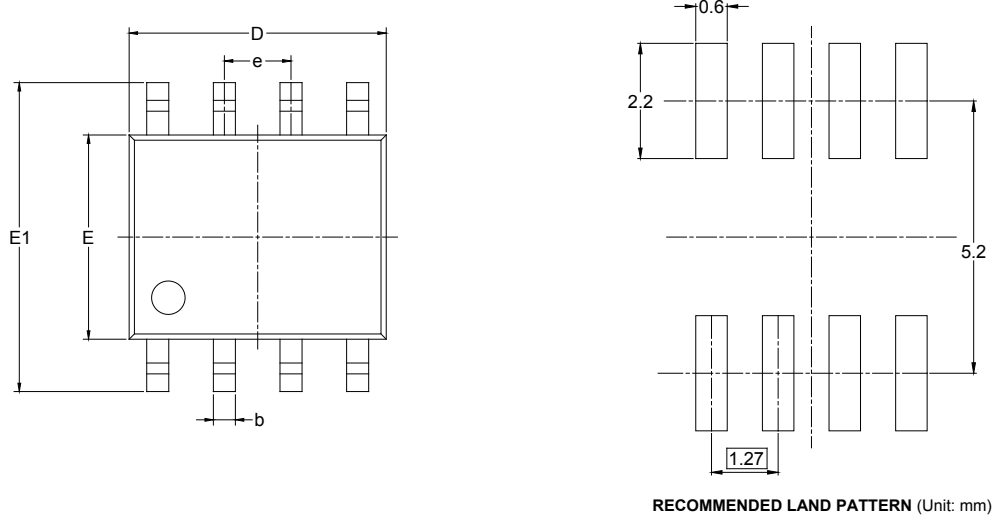
RECOMMENDED LAND PATTERN (Unit: mm)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950 BSC		0.037 BSC	
e1	1.900 BSC		0.075 BSC	
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

PACKAGE OUTLINE DIMENSIONS

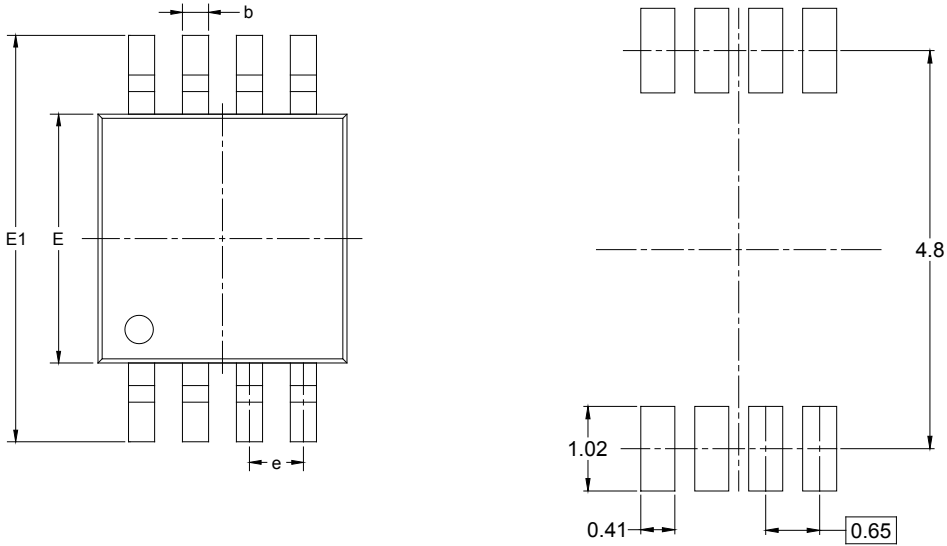
SOIC-8



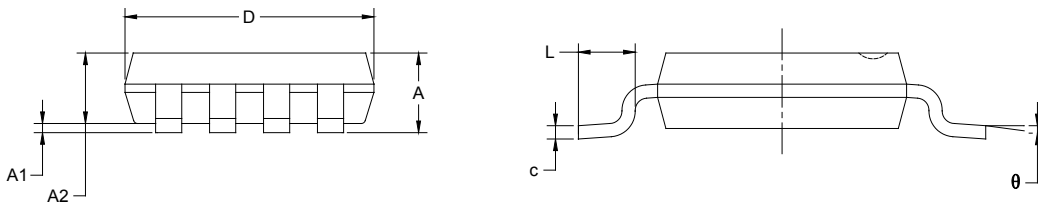
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.27 BSC		0.050 BSC	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

PACKAGE OUTLINE DIMENSIONS

MSOP-8



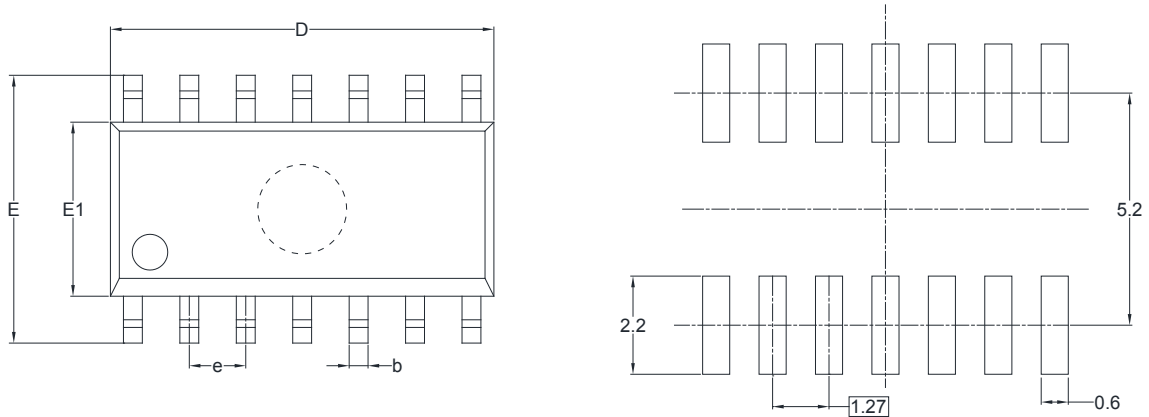
RECOMMENDED LAND PATTERN (Unit: mm)



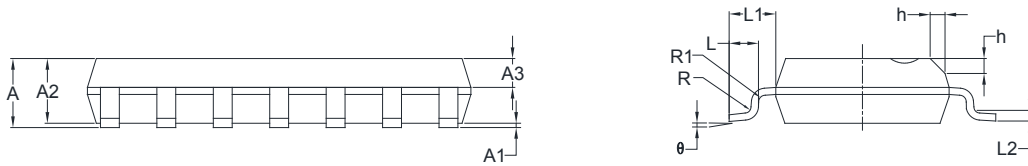
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	0.820	1.100	0.032	0.043
A1	0.020	0.150	0.001	0.006
A2	0.750	0.950	0.030	0.037
b	0.250	0.380	0.010	0.015
c	0.090	0.230	0.004	0.009
D	2.900	3.100	0.114	0.122
E	2.900	3.100	0.114	0.122
E1	4.750	5.050	0.187	0.199
e	0.650 BSC		0.026 BSC	
L	0.400	0.800	0.016	0.031
θ	0°	6°	0°	6°

PACKAGE OUTLINE DIMENSIONS

SOIC-14



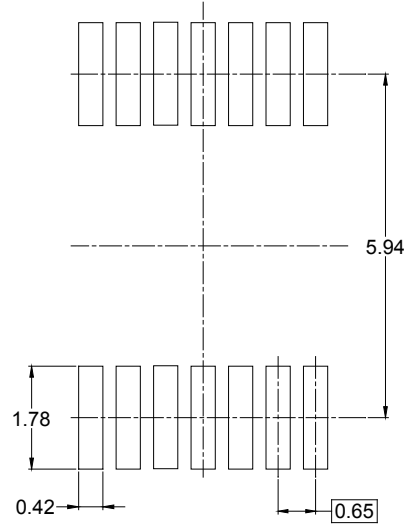
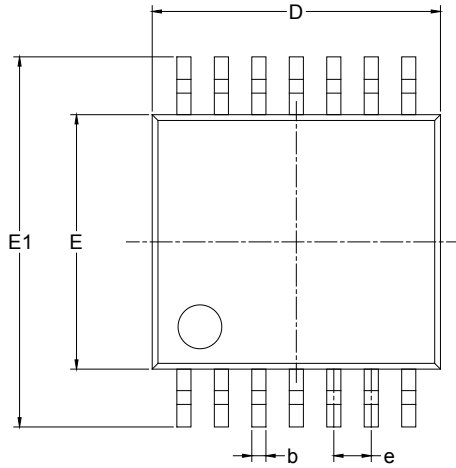
RECOMMENDED LAND PATTERN (Unit: mm)



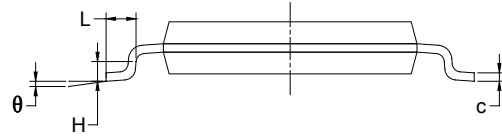
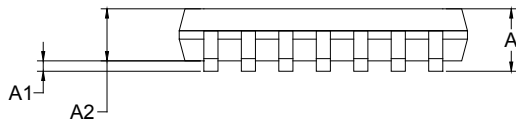
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	1.35	1.75	0.053	0.069
A1	0.10	0.25	0.004	0.010
A2	1.25	1.65	0.049	0.065
A3	0.55	0.75	0.022	0.030
b	0.36	0.49	0.014	0.019
D	8.53	8.73	0.336	0.344
E	5.80	6.20	0.228	0.244
E1	3.80	4.00	0.150	0.157
e	1.27 BSC		0.050 BSC	
L	0.45	0.80	0.018	0.032
L1	1.04 REF		0.040 REF	
L2	0.25 BSC		0.01 BSC	
R	0.07		0.003	
R1	0.07		0.003	
h	0.30	0.50	0.012	0.020
θ	0°	8°	0°	8°

PACKAGE OUTLINE DIMENSIONS

TSSOP-14



RECOMMENDED LAND PATTERN (Unit: mm)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A		1.200		0.047
A1	0.050	0.150	0.002	0.006
A2	0.800	1.050	0.031	0.041
b	0.190	0.300	0.007	0.012
c	0.090	0.200	0.004	0.008
D	4.860	5.100	0.191	0.201
E	4.300	4.500	0.169	0.177
E1	6.250	6.550	0.246	0.258
e	0.650 BSC		0.026 BSC	
L	0.500	0.700	0.02	0.028
H	0.25 TYP		0.01 TYP	
θ	1°	7°	1°	7°

PACKAGE INFORMATION

TAPE AND REEL INFORMATION

REEL DIMENSIONS



TAPE DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
SOT-23-5	7"	9.5	3.20	3.20	1.40	4.0	4.0	2.0	8.0	Q3
SOT-23-6	7"	9.5	3.17	3.23	1.37	4.0	4.0	2.0	8.0	Q3
SOIC-8	13"	12.4	6.40	5.40	2.10	4.0	8.0	2.0	12.0	Q1
MSOP-8	13"	12.4	5.20	3.30	1.50	4.0	8.0	2.0	12.0	Q1
SOIC-14	13"	16.4	6.60	9.30	2.10	4.0	8.0	2.0	16.0	Q1
TSSOP-14	13"	12.4	6.95	5.60	1.20	4.0	8.0	2.0	12.0	Q1

D00001

PACKAGE INFORMATION

CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton
7" (Option)	368	227	224	8
7"	442	410	224	18
13"	386	280	370	5

DD0002

单击下面可查看定价，库存，交付和生命周期等信息

[>>SGMICRO\(圣邦微电子\)](#)